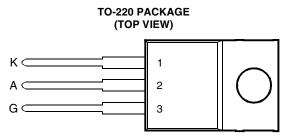
TIC116 SERIES SILICON CONTROLLED RECTIFIERS

BOURNS®

- 8 A Continuous On-State Current
- 80 A Surge-Current
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I_{GT} of 20 mA



Pin 2 is in electrical contact with the mounting base.

MDC1ACA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
	TIC116D		400	V
Departitive people off state voltage	TIC116M	V	600	
Repetitive peak off-state voltage	TIC116S	V _{DRM}	700	v
	TIC116N		800	
	TIC116D		400	V
	TIC116M	N/	600	
Repetitive peak reverse voltage	TIC116S	V _{RRM}	700	
	TIC116N		800	
Continuous on-state current at (or below) 70°C case temperature (see Note 1)	1	I _{T(RMS)}	8	А
Average on-state current (180° conduction angle) at (or below) 70°C case temp	erature		5	А
(see Note 2)		I _{T(AV)}	5	A
Surge on-state current at (or below) 25°C case temperature (see Note 3)		I _{TM}	80	А
Peak positive gate current (pulse width \leq 300 μ s)		I _{GM}	3	А
Peak gate power dissipation (pulse width \leq 300 μ s)		P _{GM}	5	W
Average gate power dissipation (see Note 4)		P _{G(AV)}	1	W
Operating case temperature range		Т _С	-40 to +110	°C
Storage temperature range		T _{stg}	-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds		TL	230	°C

NOTES: 1. These values apply for continuous dc operation with resistive load. Above 70°C derate linearly to zero at 110°C.

2. This value may be applied continuously under single phase 50 Hz half-sine-wave operation with resistive load. Above 70°C derate linearly to zero at 110°C.

3. This value applies for one 50 Hz half-sine-wave when the device is operating at (or below) the rated value of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

4. This value applies for a maximum averaging time of 20 ms.



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	PARAMETER		TEST CONDITION	ONS	MIN	ТҮР	MAX	UNIT
I _{DRM}	Repetitive peak off-state current	V_{D} = rated V_{DRM}		T _C = 110°C			2	mA
I _{RRM}	Repetitive peak reverse current	V_{R} = rated V_{RRM}	$I_{G} = 0$	T _C = 110°C			2	mA
I _{GT}	Gate trigger current	V _{AA} = 12 V	R _L = 100 Ω	t _{p(g)} ≥ 20 μs		8	20	mA
		V _{AA} = 12 V t _{p(g)} ≥ 20 µs	R _L = 100 Ω	$T_{C} = -40^{\circ}C$			2.5	
V _{GT}	Gate trigger voltage	V _{AA} = 12 V t _{p(g)} ≥ 20 µs	R _L = 100 Ω			0.8	1.5	v
		V _{AA} = 12 V t _{p(g)} ≥ 20 µs	R _L = 100 Ω	T _C = 110°C	0.2			
I _H	Holding current	$V_{AA} = 12 V$ Initiating I _T = 100 mA		$T_{\rm C} = -40^{\circ}{\rm C}$			100	mA
		$V_{AA} = 12 V$ Initiating I _T = 100 mA					40	in/ (
V _T	On-state voltage	I _T = 8 A	(see Note 5)				1.7	V
dv/dt	Critical rate of rise of off-state voltage	$V_{D} = rated V_{D}$	I _G = 0	$T_{C} = 110^{\circ}C$		400		V/µs

electrical characteristics at 25°C case temperature (unless otherwise noted)

NOTE 5: This parameter must be measured using pulse techniques, $t_p = 300 \ \mu$ s, duty cycle $\le 2 \ \%$. Voltage sensing-contacts, separate from the current carrying contacts, are located within 3.2 mm from the device body.

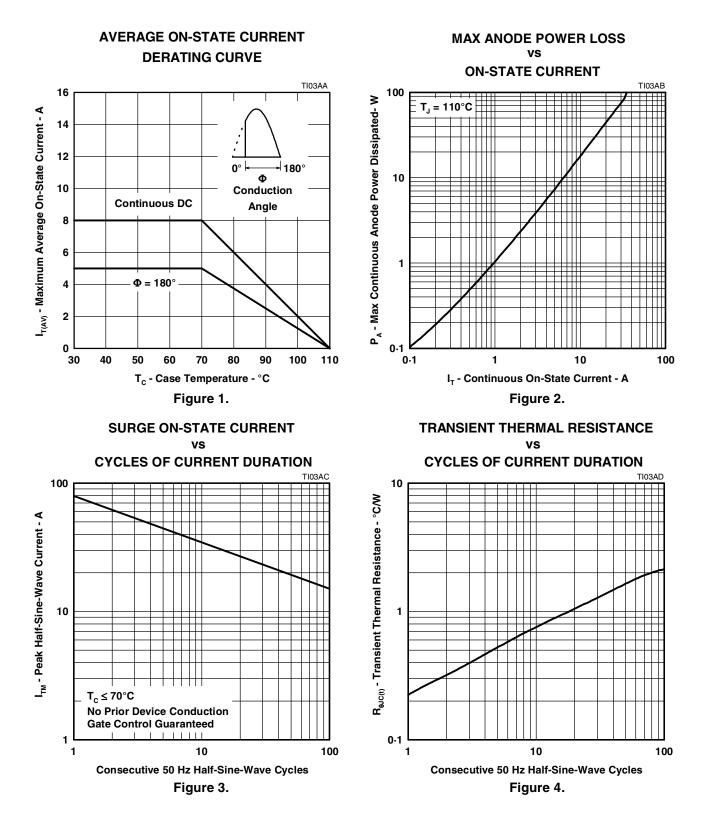
thermal characteristics

PARAMETER		ТҮР	MAX	UNIT
R _{0JC} Junction to case thermal resistance			3	°C/W
R _{0JA} Junction to free air thermal resistance			62.5	°C/W





THERMAL INFORMATION

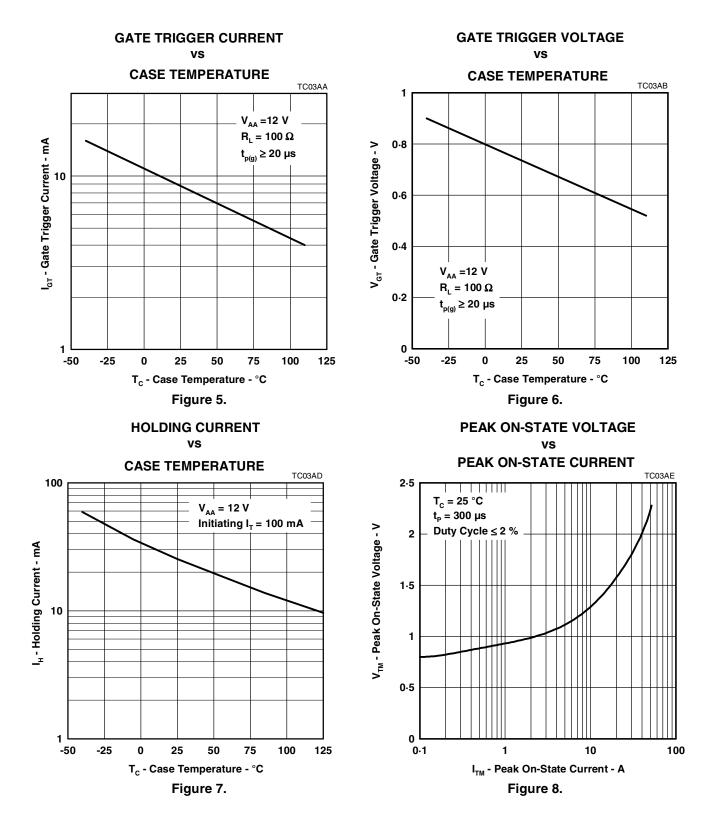


PRODUCT INFORMATION

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TYPICAL CHARACTERISTICS



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